2-292141-8 - ACTIVE

AMP CT

TE Internal #: 2-292141-8 PCB Mount Header, Vertical, Wire-to-Board, 28 Position, 2 mm [. 079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Power & Signal, AMP CT

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > CT 2mm Dbl Row Assembly w/Boss: Vert.



Connector System: Wire-to-Board

Number of Positions: 28

Number of Rows: 2

Centerline (Pitch): 2 mm [.079 in]

PCB Mount Orientation: Vertical

All CT 2mm Dbl Row Assembly w/Boss: Vert. (26)

Features

Product Type Features

Connector System

Header Type

Wire-to-Board

Fully Shrouded



Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Number of Positions	28
Number of Rows	2
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	125 VAC
Body Features	
Primary Product Color	Natural
Contact Features	
Contact Mating Area Length	4.7 mm[.185 in]
PCB Contact Termination Area Plating Material Thickness	1 μm[39.37 μin]

PCB Mount Header, Vertical, Wire-to-Board, 28 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Power & Signal, AMP CT



Contact Layout	Inline
Mating Pin Diameter	.6 mm[.024 in]
Contact Mating Area Plating Material Thickness	1 μm[39.37 μin]
Contact Shape & Form	Round, Rounded
Contact Mating Area Plating Material Finish	Matte
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Brass
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	4 A
Termination Features	
Round Termination Post & Tail Diameter	.6 mm[.024 in]
Termination Post & Tail Length	3.2 mm[.126 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
PCB Mount Alignment Type	Boss
Mating Alignment Type	Polarization
Mating Retention	Without
PCB Mount Retention Type	Boardlock
Mating Retention Type	Polarized Lock
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	With
PCB Mount Retention	With
Housing Features	
Housing Material	66 Nylon
Centerline (Pitch)	2 mm[.079 in]
Dimensions	
Connector Length	33.9 mm[1.334 in]
Connector Height	7.5 mm[.295 in]
Connector Width	10.7 mm[.421 in]
PCB Thickness (Recommended)	1.6 mm[.063 in]
Row-to-Row Spacing	

L For support call+1 800 522 6752

PCB Mount Header, Vertical, Wire-to-Board, 28 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Power & Signal, AMP CT



Usage Conditions	
Operating Temperature Range	-22 – 221 °C[-30 – 105 °F]
Operation/Application	
Assembly Process Feature	Pick and Place Cover
Circuit Application	Power & Signal
Industry Standards	
Agency/Standard	CSA, UL
Approved Standards	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	130
Packaging Type	Box, Tray
Product Compliance	
For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant

EU ELV Directive 2000/53/EC

Compliant

China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 240°C

Solder Process Capability

wave solder capable to 240 C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides

PCB Mount Header, Vertical, Wire-to-Board, 28 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Power & Signal, AMP CT



on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series AMP CT



Customers Also Bought



PCB Mount Header, Vertical, Wire-to-Board, 28 Position, 2 mm [.079 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Power & Signal, AMP CT



TE Part #9-292131-3 SGL HDR ASSY BOX DIP V POLARIS

Documents

Product Drawings CT DOUBLE ROW ASSY V 28P W/BOS

English

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2-292141-8_O.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2-292141-8_O.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2-292141-8_O.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications

Product Specification

English

Product Specification

English

CT DOUBLE ROW CONNECTOR, LEAD FREE VERSION

Japanese

Product Specification

Japanese